

**SONY****2SK152****Silicon N-Channel Junction FET****Description**

The 2SK152 is the first device to reach such a high "Figure of merit" level. Because it uses the latest Epitaxy and Pattern technology.

Head amplifiers Video Cameras VTRs etc. perform very efficiently.

**Features**

- High figure of merit  
 $V_{DS} = 5V$  |  $Y_{fs}$  |  $C_{iss}$  3.5 (Typ.)  
 $I_D = 10mA$
- High |  $Y_{fs}$  |  
 $V_{DS} = 5V$  |  $Y_{fs}$  | 30mS (Typ.)  
 $V_{GS} = 0V$
- Low input capacitance  
 $C_{iss}$  8pF (Typ.)

**Structure**

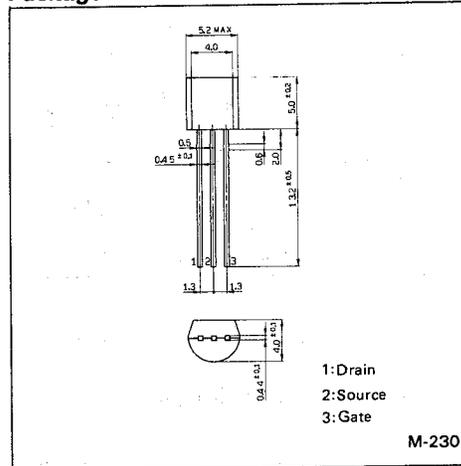
Silicon N-Channel junction FET.

**Absolute Maximum Ratings ( $T_a = 25^\circ C$ )**

• Drain to gate voltage	$V_{DGO}$	15	V
• Source to gate voltage	$V_{SGO}$	15	V
• Drain current	$I_D$	50	mA
• Gate current	$I_G$	5	mA
• Junction temperature	$T_j$	100	$^\circ C$
• Storage temperature	$T_{stg}$	- 50 to + 120	$^\circ C$
• Allowable power dissipation	$P_D$	300	mW

**Package Outline**

Unit: mm



1: Drain  
 2: Source  
 3: Gate

M-230

**Electrical Characteristics**

Ta = 25°C

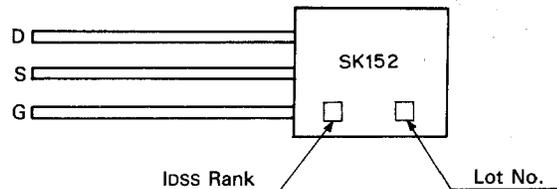
Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Drain to gate voltage	VDGO	IG = 10μA	15			V
Source to gate voltage	VSGO	IG = 10μA	15			V
Gate cutoff current	IGSS	VGS = -7V, VDS = 0V			-2	nA
Drain current	IDSS	VDS = 5V, VGS = 0V	9.5		42	mA*
Gate to source cutoff voltage	VGS(OFF)	VDS = 5V, ID = 100μA	-0.55		-2.0	V
Forward transfer admittance	Yfs	VDS = 5V, VGS = 0V, f = 1kHz	21	30		mS
Input capacitance	Ciss	VDS = 5V, VGS = 0V, f = 1MHz		8	9	pF

\*Note) Drain current detail specification as follows.

**Classification**

Rank	IDSS(mA) VDS = 5V VGS = 0V
1	9.5 to 14.8
2	13.4 to 21.0
3	19.0 to 30.2
4	27.4 to 42.0

**Mark**

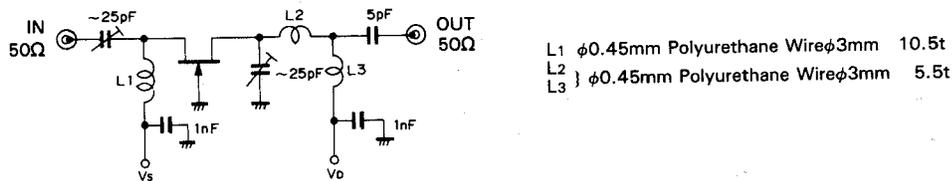


Standard Circuit Design Data

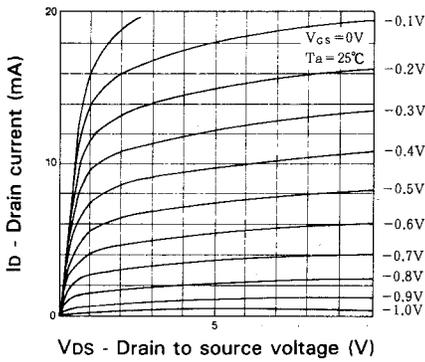
Ta = 25°C

Item	Symbol	Condition	Typ.	Unit
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 5V, I_D = 10mA, f = 1kHz$	25	mS
Input capacitance	$C_{iss}$	$V_{DS} = 5V, I_D = 10mA, f = 1MHz$	7.2	pF
Gate cutoff current	$I_G$	$V_{DG} = 5V, I_D = 10mA$	40	pA
Input resistance	$r_{is}$	$V_{DS} = 5V, I_D = 10mA, f = 100MHz$	3.5	kΩ
Input capacitance	$C_{is}$		7.2	pF
Output resistance	$r_{os}$		3	kΩ
Output capacitance	$C_{os}$		2.5	pF
Power gain	PG		15	dB
Noise figure	NF		1.8	dB
Equivalent input noise voltage	$\bar{e}_n$	$V_{DS} = 5V, I_D = 10mA$ $f = 1kHz, R_g = 0\Omega$	1.2	nV/ $\sqrt{Hz}$
Reverse transfer capacitance	$C_{rss}$	$V_{DS} = 5V, V_{GS} = 0V, f = 1MHz$	2.0	pF

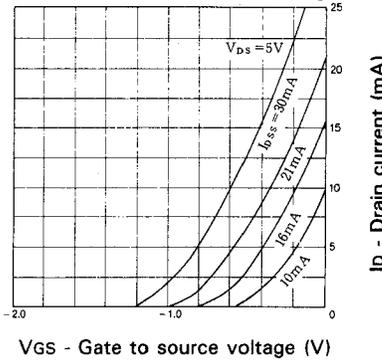
100 MHz PG, NF Test Circuit



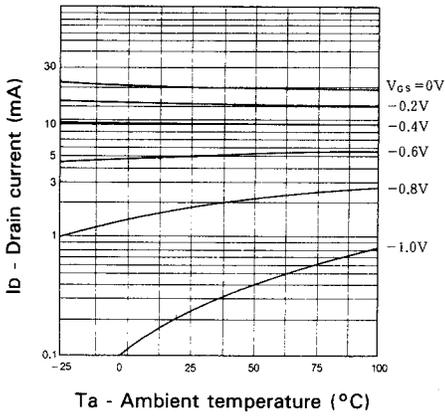
**Drain current vs. Drain to source voltage**



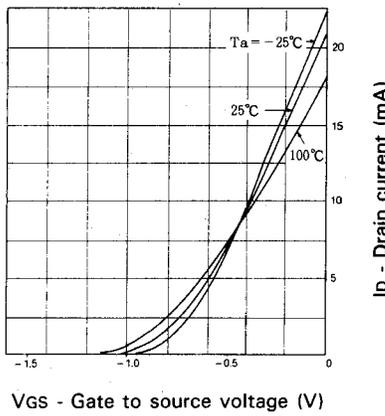
**Drain current vs. Gate to source voltage**



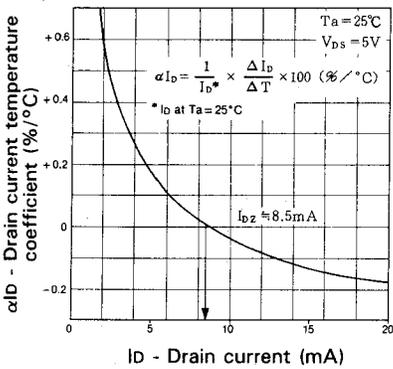
**Drain current vs. Ambient temperature**



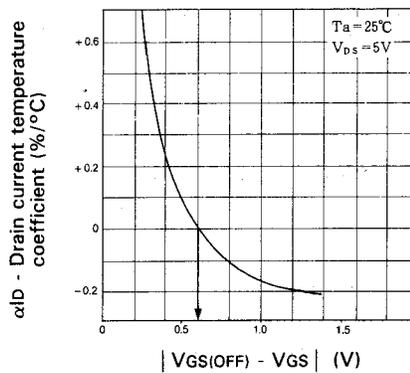
**Transfer characteristics vs. Ambient temperature**



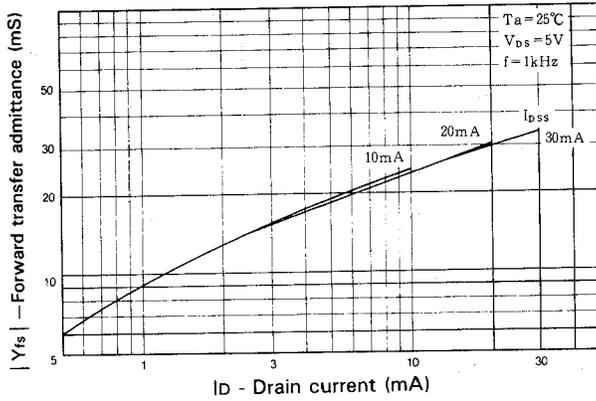
**Drain current temperature coefficient vs. Drain current**



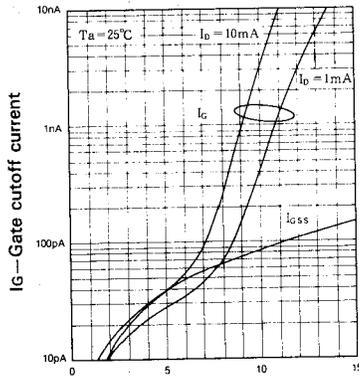
**Drain current temperature coefficient vs. Gate cutoff voltage**



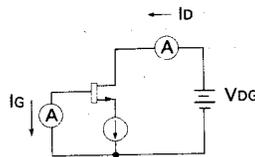
Forward transfer admittance vs. Drain current



Gate cutoff current vs. Bias voltage

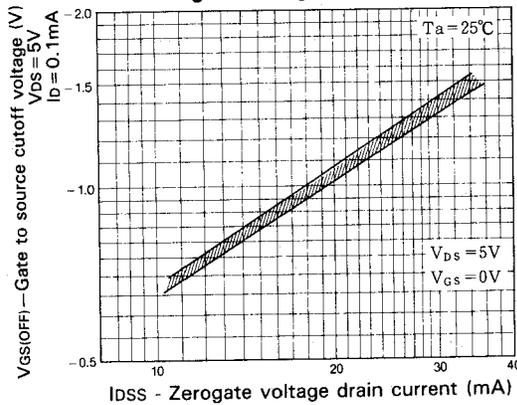


IG Test Circuit

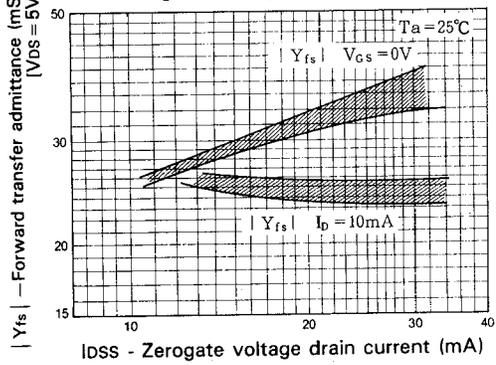


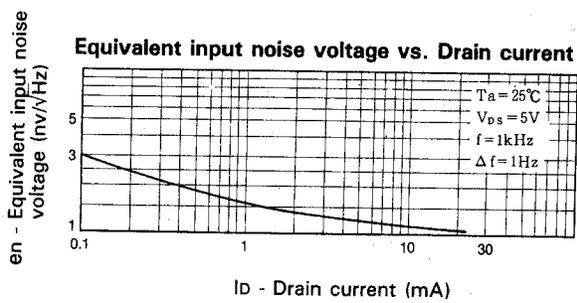
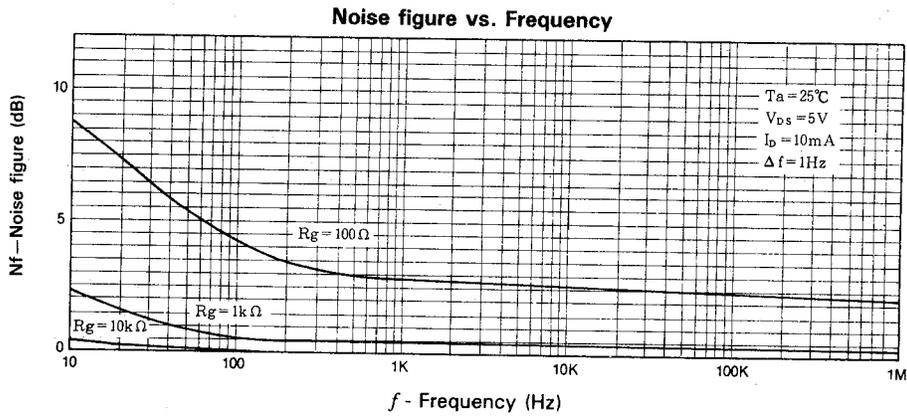
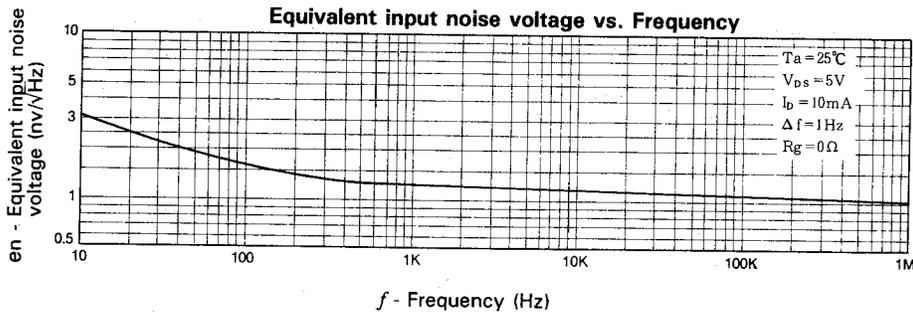
$V_{DG}$  - Drain gate voltage (V)  
 $V_{GS}$  - Gate to source voltage (V)

Gate to source cutoff voltage vs. Zerogate voltage drain current

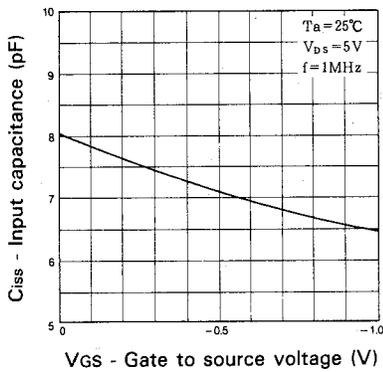


Forward transfer admittance vs. Zerogate voltage drain current

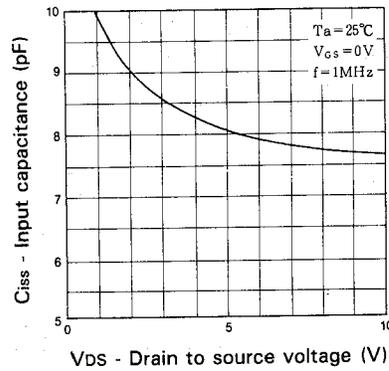




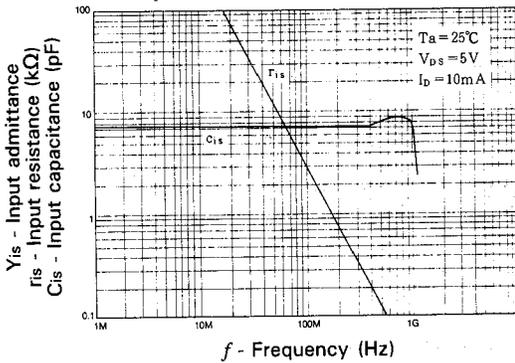
**Input capacitance vs. Gate to source voltage**



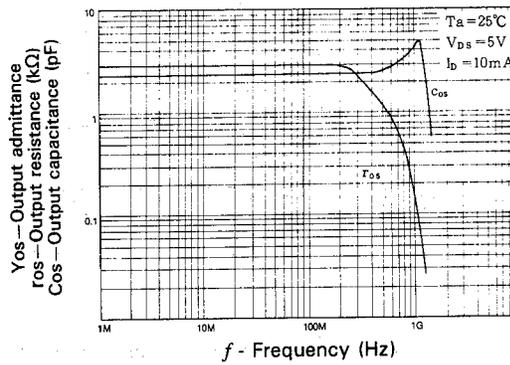
**Input capacitance vs. Drain to source voltage**



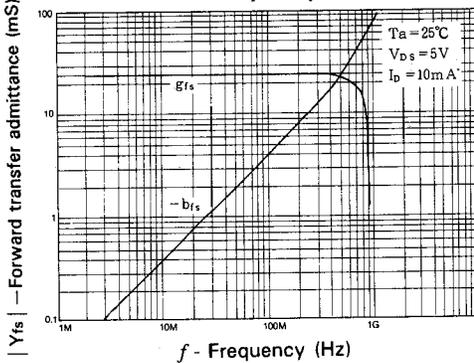
**Input admittance vs. Frequency**



**Output admittance vs. Frequency**



**Forward transfer admittance vs. Frequency**



**Reverse transfer admittance vs. Frequency**

